

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

[Lumex, Inc.](#)
[SSP-FSD8DUPG-12V3](#)

For any questions, you can email us directly:

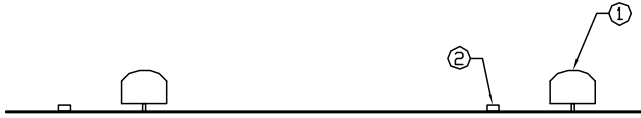
sales@integrated-circuit.com

UNCONTROLLED DOCUMENT

PART NUMBER
 SSP-FSD8DUPG-12V3

REV.

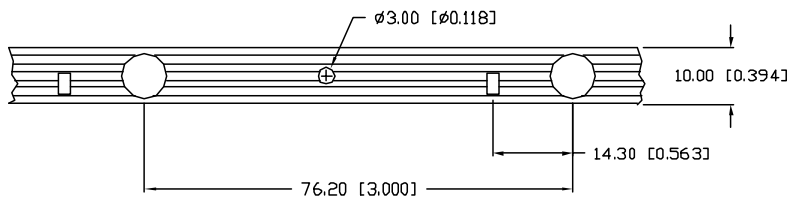
CAUTION: STATIC SENSITIVE DEVICE
 FOLLOW PROPER E.S.D. HANDLING PROCEDURES
 WHEN WORKING WITH THIS PART.



ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^{\circ}\text{C}$ $V_f=12\text{V}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		525		nm	
FORWARD VOLTAGE		12		V_f	
REVERSE VOLTAGE	5.0			V_r	$I_f=100\mu\text{A}$
AXIAL INTENSITY*		1200		mcd	$V_f=12\text{V}$
VIEWING ANGLE		85		2x theta	
EMITTED COLOR:	GREEN				
EPOXY LENS FINISH:	WATER CLEAR				

*PER LED



LIMITS OF SAFE OPERATION AT 25°C PER LED

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	100	mA
STEADY CURRENT	20	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.2	mW/°C
OPERATING, STORAGE TEMP.	-40 TO +85	°C
SOLDERING TEMP.	+260	°C
2.0mm FROM BODY		3 SEC. MAX


* $t < 10\mu\text{s}$

NOTES:

- SSL-LX806F3UPGC
- 1/8W 470Ω RESISTOR.

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*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030), MIN=-0.00, MAX=+0.00, DECIMAL PRECISION

REV.	PART NUMBER SSP-FSD8DUPG-12V3	CONFIDENTIAL INFORMATION THE INFORMATION CONTAINED IN THIS DOCUMENT IS THE PROPERTY OF SUNBRITE LEDS. EXCEPT AS SPECIFICALLY AUTHORIZED IN WRITING BY SUNBRITE LEDS, THE HOLDER OF THIS DOCUMENT SHALL KEEP ALL INFORMATION CONTAINED HEREIN CONFIDENTIAL AND SHALL PROTECT SAME IN WHOLE OR IN PART FROM DISCLOSURE AND DISSEMINATION TO ALL THIRD PARTIES.		286 E. HELEN ROAD PALATINE, IL 60067-6976 PHONE: +1.847.359.2790 FAX: +1.847.359.2867 WEB: www.sunbriteleds.com		
8mm STRIP LED, 3" SPACING, 525nm InGaN/SiC GREEN LED, WATER CLEAR LENS.		RELIABILITY NOTE OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.		DRAWN: BC	CHECKED:	APPROVED: